

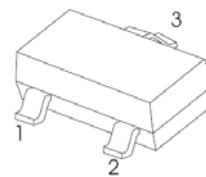


## SWITCHING DIODE

## FEATURES

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automatic Insertion
- For General Purpose Switching Applications
- High Conductance

SOT-23



BAS21	BAS21A	BAS21C	BAS21S
MARKING: JS	MARKING:JS2	MARKING:JS3	MARKING:JS4

Solid dot = Green molding compound device,  
if none, the normal device

## Maximum Ratings @Ta=25°C

Parameter	Symbol	Limit	Unit
Repetitive peak reverse voltage	V <sub>RRM</sub>		
Working peak reverse voltage	V <sub>RWM</sub>	250	V
DC blocking voltage	V <sub>R</sub>		
Forward continuous current	I <sub>FM</sub>	400	mA
Average rectified output current	I <sub>O</sub>	200	mA
Non-Repetitive Peak Forward Surge Current @t=8.3ms	I <sub>FSM</sub>	2.5	A
Repetitive peak forward surge current	I <sub>FRM</sub>	625	mA
Power dissipation	P <sub>D</sub>	225	mW
Thermal resistance junction to ambient	R <sub>θJA</sub>	555	°C/W
Junction temperature	T <sub>J</sub>	150	°C
Storage temperature range	T <sub>STG</sub>	-55~+150	°C

## ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Max	Unit
Reverse breakdown voltage	V <sub>(BR)</sub>	I <sub>R</sub> = 100μA	250		V
Reverse voltage leakage current	I <sub>R</sub>	V <sub>R</sub> =200V		0.1	μA
Forward voltage	V <sub>F</sub>	I <sub>F</sub> =100mA I <sub>F</sub> =200mA		1000 1250	mV
Diode capacitance	C <sub>D</sub>	V <sub>R</sub> =0V, f=1MHz		5	pF
Reveres recovery time	t <sub>rr</sub>	I <sub>F</sub> =I <sub>R</sub> =30mA, I <sub>rr</sub> =0.1×I <sub>R</sub> , R <sub>L</sub> =100 Ω		50	ns

## Typical Characteristics

